

SPECIFICATIONS

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1. Scope of Application

These specifications are applied to the chip type LED lamp , model CL-824-MU1WW1-T

2. Part code

CL - 824 - MU1 WW1 - T

Series

824 : White LED for general lighting.

Special specifications

M : General Color Rendering Index Typ. 85 Type.

Watt Class

U1 : Under 1 watt package.

Lighting color

WW1 : Energy Star Correlated Color Temperature 3500(K)

Shipping mode

Non-coded : Bulk

T : Taping (standard)

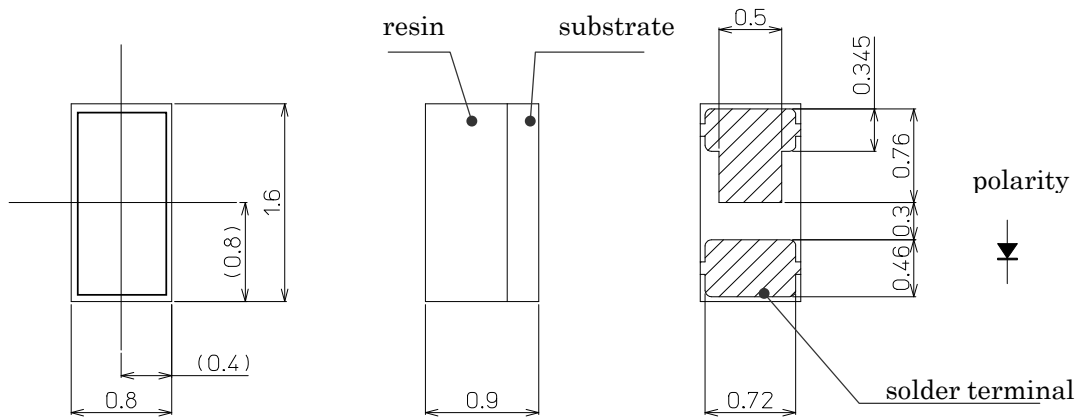
			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1WW1
						Drawing No	
	2009/7/29	Issue of second edition.					
	2009/6/5	Issue of first edition.					
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3. Outline drawing

Unit: mm
Tolerance: ±0.1



4. Performance

(1) Absolute Maximum Rating

Parameter	Symbol	Rating Value	Unit
Power Dissipation	P _d	108	mW
Forward Current	I _F	30	mA
Forward Pulse Current	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{OP}	-30 ~ +85	C
Storage Temperature	T _{ST}	-40 ~ +100	C
Junction Temperature	T _{j Max}	120	C

*1 Forward Current : Duty ≤ 1/10 , Pulse Width ≤ 0.1 msec

*2 D.C. Current : T_j = T_c + R_{j-s} × P_d

Pulse Current : T_j = T_c + R_{j-s} × P_w (Power Dissipation / one-Pulse) × duty

※T_c: Temperature of anode solder terminal

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(2) Electro-optical Characteristics (T_c=25C)

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Forward Voltage	V _F	I _F =20mA	2.8	3.2	3.5	V
Reverse Current	I _R	V _R =5V	-	-	100	μA
Thermal resistance	R _{θj-s}	Junction-solder	-	175	-	C/W
Luminous Intensity*1	I _v	I _F =20mA	1140	1670	-	mcd
Luminous Flux	φ _v	I _F =20mA	-	(4.7)	-	lm
General Color Rendering Index	Ra	I _F =20mA	80	85	-	-

*1 In accordance with NIST standard

Ranking (Condition : I_F=20mA , T_c=25C)

Parameter	Symbol	Rank	MIN	MAX	Unit
Forward Voltage	V _F	Q	2.8	3.0	V
		R	3.0	3.2	
		S	3.2	3.5	
Luminous Intensity	I _v	B	1140	1300	mcd
		C	1300	1759	
		D	1759	2380	

Chromaticity coordinates

(Condition : I_F=20mA , T_c=25C)

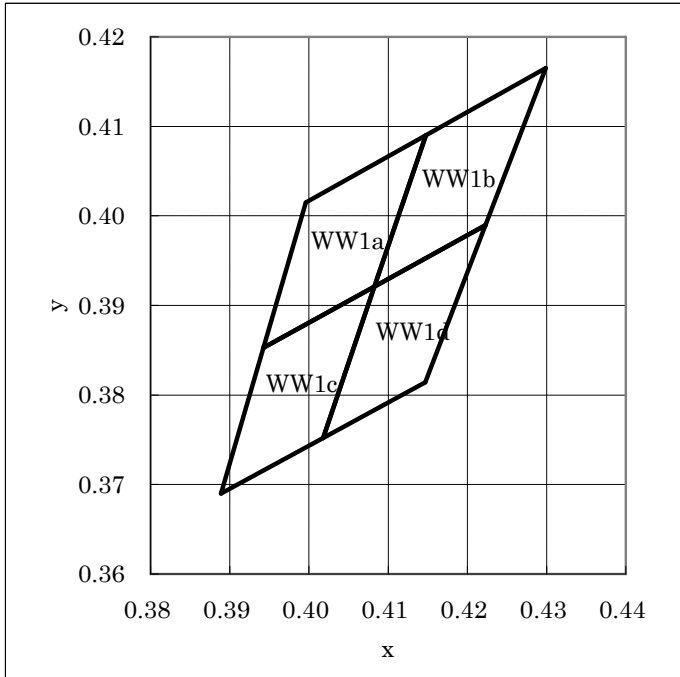
Color Rank	x	y	Color Rank	x	y
WW1a	0.4148	0.4090	WW1b	0.4299	0.4165
	0.3996	0.4015		0.4148	0.4090
	0.3943	0.3853		0.4083	0.3921
	0.4083	0.3921		0.4223	0.3990

Color Rank	x	y	Color Rank	x	y
WW1c	0.4083	0.3921	WW1d	0.4223	0.3990
	0.3943	0.3853		0.4083	0.3921
	0.3889	0.3690		0.4018	0.3752
	0.4018	0.3752		0.4147	0.3814

Note 1) The tolerance of measurement at our tester is V_F±3% , φ_v±10% , Chromaticity(x,y)±0.01.


Note 2) For handling ,please apply CMOS LSI or equivalent any electrostatic effect.


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Rank information

CUSTOMER:
TYPE: CL-824-MU1WW1
P.NO:
Lot No: XXXXXX
Q'ty: XXX






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e.g. B WW1a Q

↓


-  : Ranking by Luminous Intensity
-  : Ranking by Chromaticity coordinates
-  : Ranking by Forward Voltage

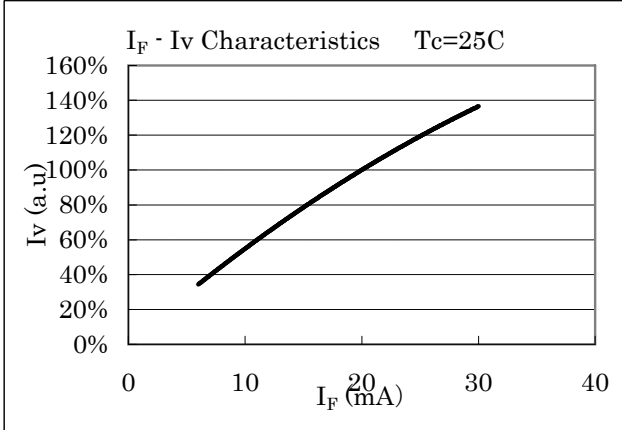
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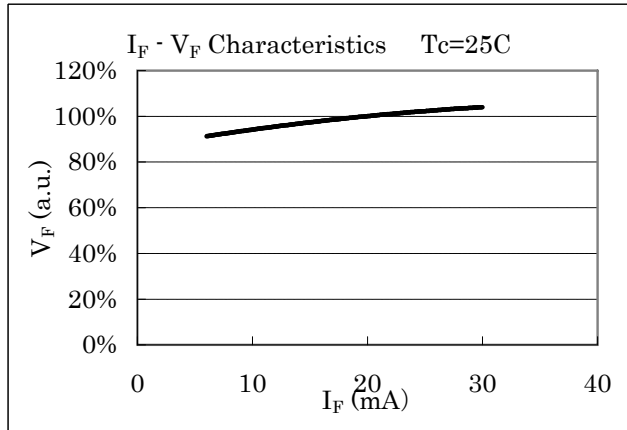
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5. Characteristics

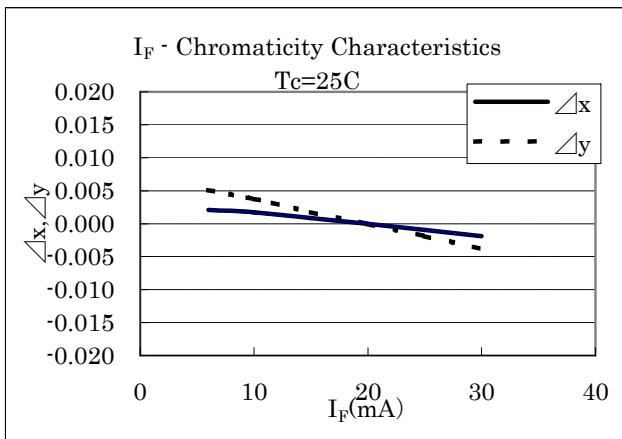
Forward Current vs. Relative Luminous Intensity



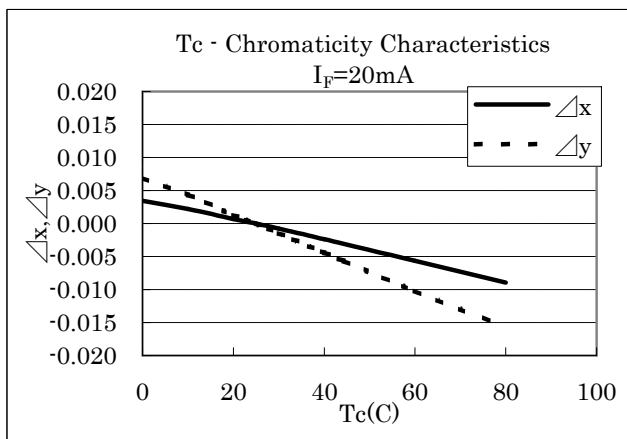
Forward Current vs. Forward Voltage



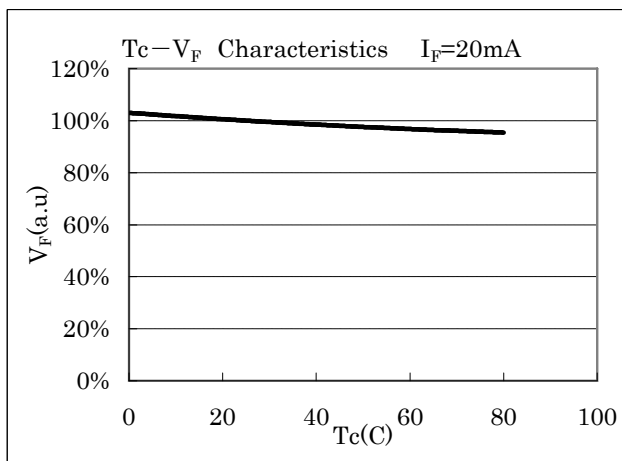
Forward Current vs. Chromaticity Coordinate



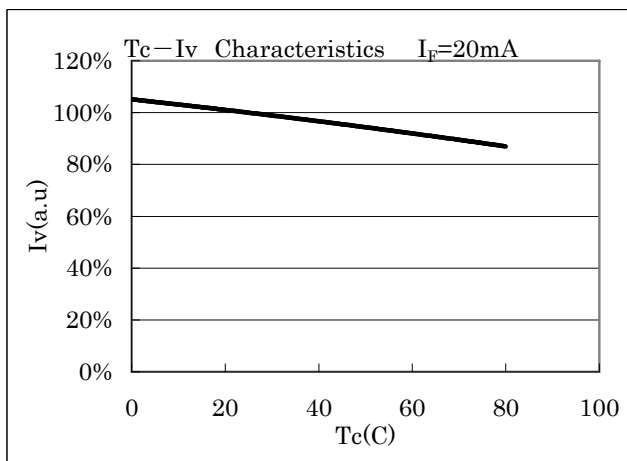
Case Temperature vs. Chromaticity Coordinate



Case Temperature vs. Forward Voltage



Case Temperature vs. Relative Luminous Intensity

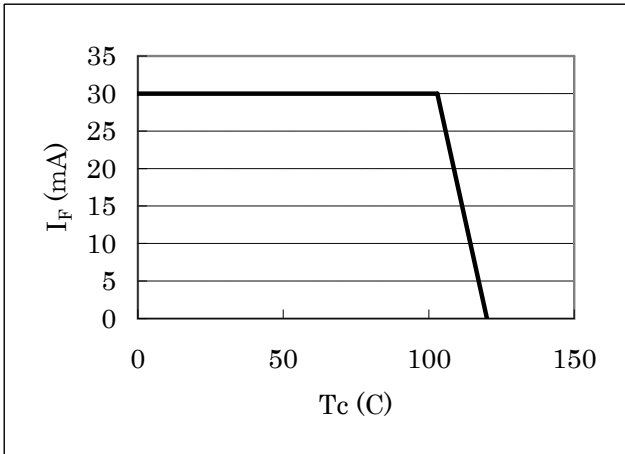


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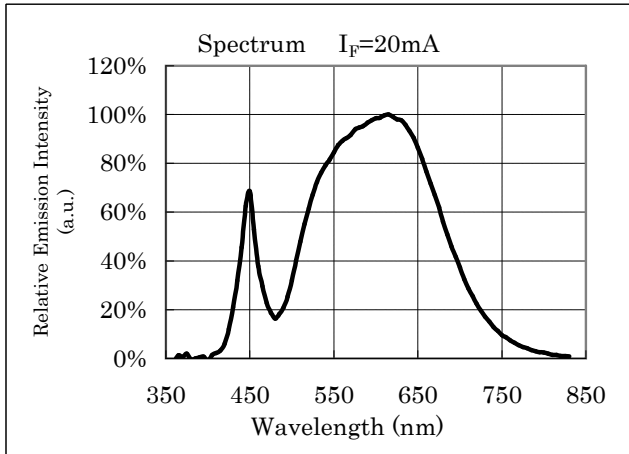
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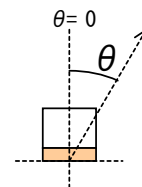
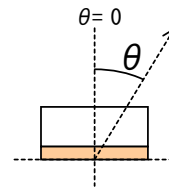
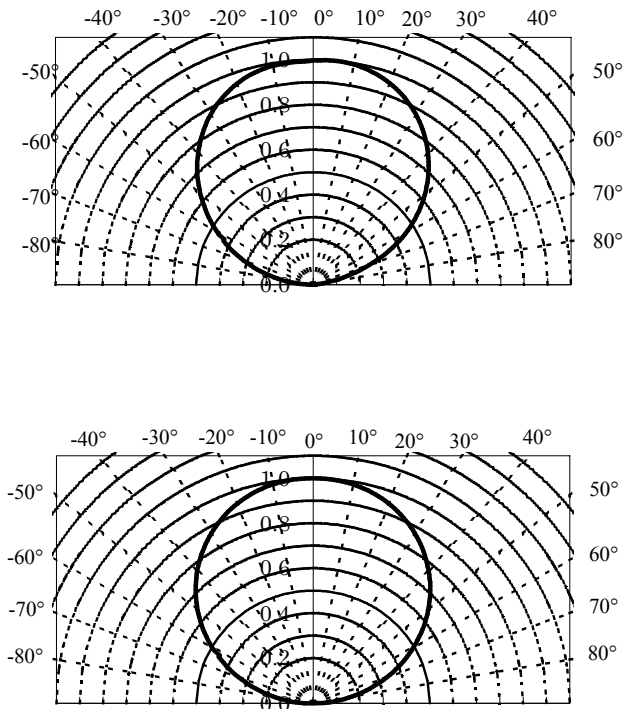
Case Temperature vs. Allowable Forward Current



Spectrum



Directive Characteristic



*Measurement condition (directive characteristic)
LED chip is mounted on black color PCB.

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6. Reliability

(1)Details of the tests

Test Item	Test Condition
Life Test in Continuous Operation	25±3C, I _F =20 mA , 1000 _{+24/-12} hours
Low Temperature Storage Test	-40 _{+3/-5} C , 1000 _{+24/-12} hours
High Temperature Storage Test	100 _{+5/-3} C , 1000 _{+24/-12} hours
Moisture-proof Test	60 ±2°C, 90 ±5%RH for 1000 _{+24/-12} hours
Thermal Shock Test	-40C , 30 minutes and 100C , 30 minutes, 100cycle
Solder Heat Resistance Test	Recommended temperature profile (reflow soldering) × 2, (2nd test must be started after the samples are stabilized thermally.)

(2)Judgment Criteria of Failure for Reliability Test (T_a=25C)

Measuring Item	Symbol	Measuring Condition	Judgement Criteria for Failure
Forward Voltage	V _F	I _F =20mA	>U×1.2
Reverse Current	I _R	V _R =5V	>U×2
Luminous Intensity	I _V	I _F =20mA	<S×0.7

U defines the upper limit of the specified characteristics.S defines the initial value.

Note: Measurement shall be taken between 2 hours and 24 hours, and the test pieces should be returned to the normal ambient conditions after the completion of each test.

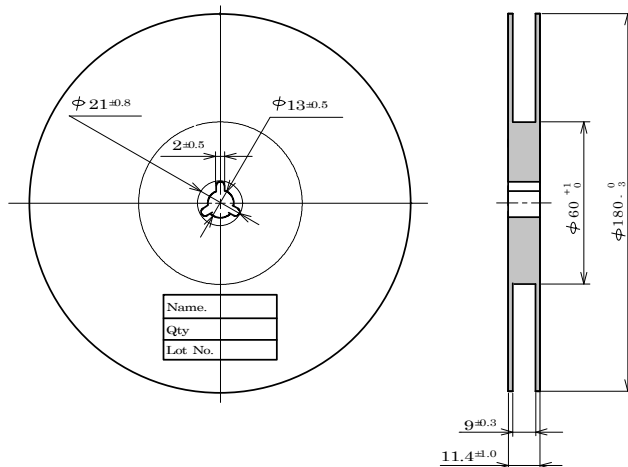
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7. Taping Specifications (in accordance with JIS standard)

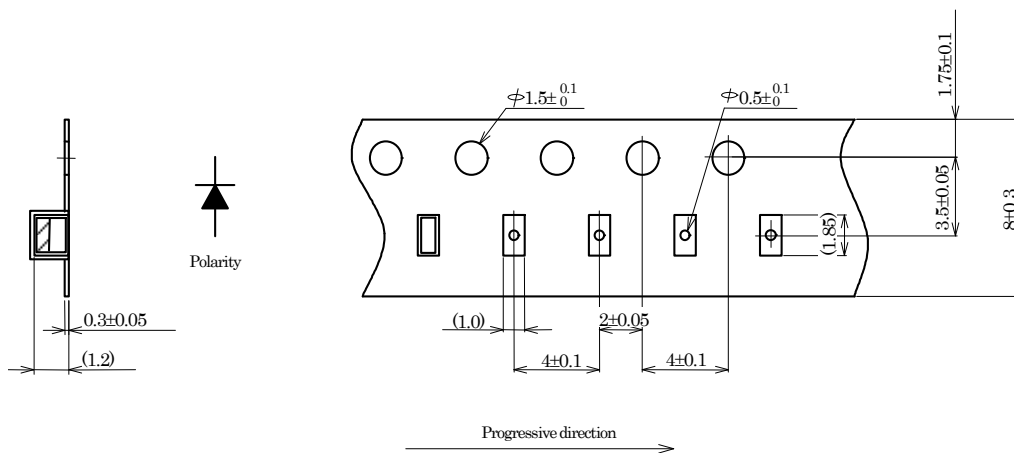
(1) Shape and Dimensions of Reel

(Unit: mm)

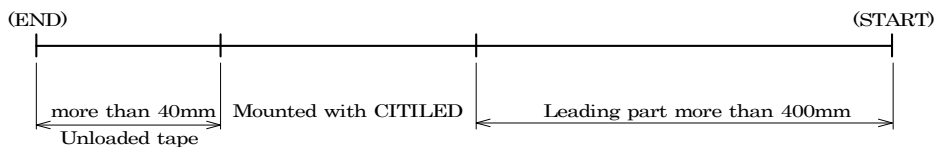


(2) Dimensions of Tape

(Unit: mm)



(3) Configuration of Tape



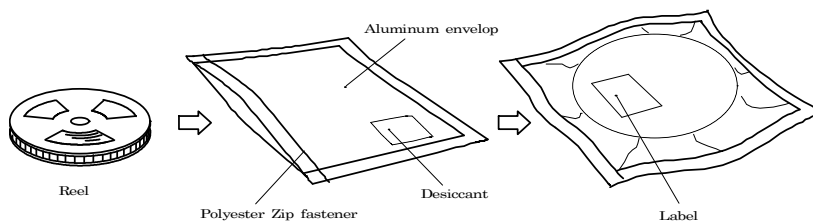
(4) Quantity: 2500pcs/reel

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8. Packing Specifications

8-1. Moisture-proof Packing

To prevent moisture absorption during transportation and storage, reels are packed in aluminum envelopes which contain a desiccant with a humidity indicator.



8-2. Storage

To prevent moisture absorption, it is strongly recommended that reels (in bulk or taped) should be stored in the dry box (or the desiccator) with a desiccant as the appropriate storage place. If not, the following is recommended.

Temperature: 5~30C
 Humidity: 60%RH max

The devices should be mounted as soon as possible after unpacking. If you store the unpacked reels, please store them in the dry box or seal them into the envelop again.

MSL 1 (IPC/JEDEC J-STD-020C)

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9. Precautions

9-1. Soldering

(1) Lead free soldering

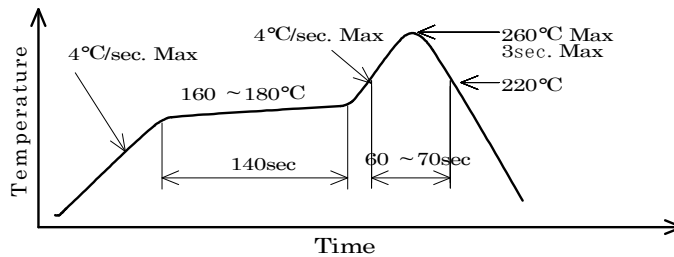
1) Following soldering paste is recommended

Melting temperature: 216 ~ 220C.

Composition: Sn 3.5Ag 0.75Cu

2) The temperature profile at the top surface of the parts is recommended as shown below.

3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature



9-2. Washing

(1) When washing after soldering is needed, following conditions are requested.

a) Washing solvent: Pure Water

b) Temperature, time: 50C or less × 30 seconds max.
or 30C or less × 3 minutes max.

c) Ultrasonic washing: 300W or less

9-3. Other directions

(1) It is requested to avoid any stress added to the resin portion while it is heated.

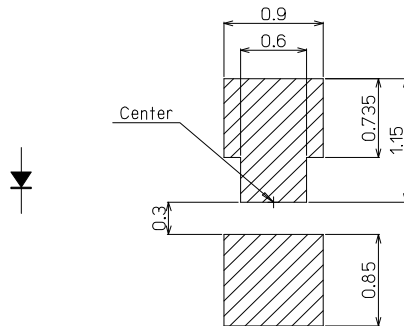
(2) It is requested to avoid any friction by sharp metal nail etc. to the resin portion.

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10. Designing precautions

- (1) The current limiting resistor should be placed in the circuit so that is driven within its rating. Also avoid reverse voltage (over-current) applied instantaneously when ON or OFF.
- (2) When pulse driving current is applied, average current consumption should be within the rating. Also avoid reverse voltage applied when put off.
- (3) Recommended soldering pattern

<For reflow soldering>

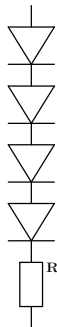


Unit : mm

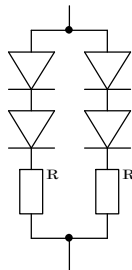
The above dimensions are not the one which guarantee the performance of mount ability. The use of the above pattern is recommended to use after deep study at your site.

- (4) When assembling the circuit board into the finished products, care must be taken to avoid the component parts from touching other parts.
- (5) When using multiple LEDs, it is required to connect a current limiting resistor on each path which the current flows to the LEDs.

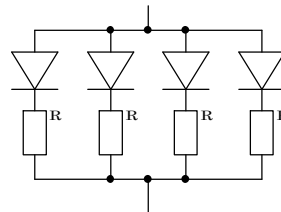
(ex-1)



(ex-2)



(ex-3)



(6) Other

- 1) This product complies with RoHs directives.
- 2) When this product is secondarily fabricated such as change in shape, it is not included in our warranty.
- 3) The agreement of formal product specification is required prior to mass production.

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